



Total solution for plating technologies

UBM Forming Process

ENIG process

Electroless Ni plating
EPITHAS NPR-18
Immersion Au plating
EPITHAS TDS-45

Solder joint reliability

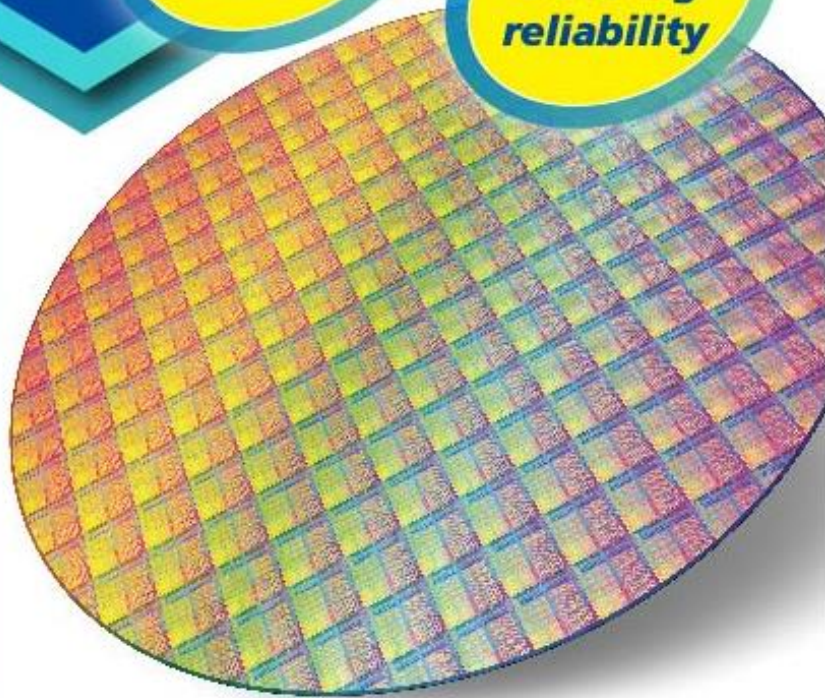
Wire bonding reliability

ENEPIG process

Electroless Ni plating
EPITHAS NPR-18
Electroless Pd plating
EPITHAS TFP-30
Immersion Au plating
EPITHAS TDS-45

ENAG process

Electroless Ni plating
EPITHAS NPR-18
Immersion Au plating
EPITHAS TDS-25
Electroless Au plating
EPITHAS TMX-16



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